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PD - 9.903A

# International Rectifier

## IRLZ14S/L

HEXFET® Power MOSFET

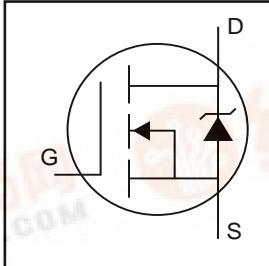
- Advanced Process Technology
- Surface Mount (IRLZ14S)
- Low-profile through-hole (IRLZ14L)
- 175°C Operating Temperature
- Fast Switching

### Description

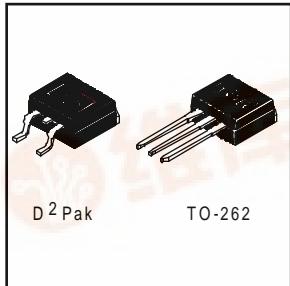
Third Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The D<sup>2</sup>Pak is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>Pak is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0W in a typical surface mount application.

The through-hole version (IRLZ14L) is available for low-profile applications.



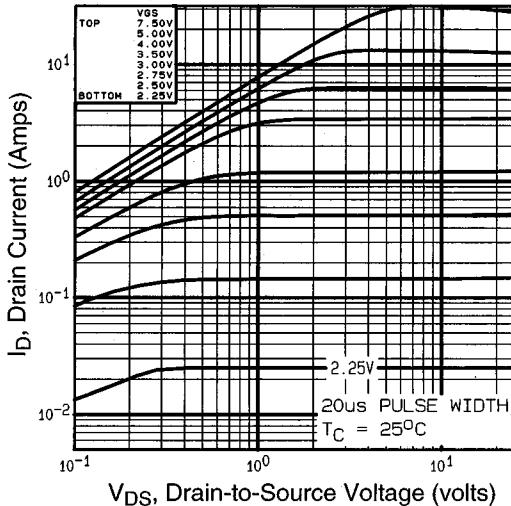
$V_{DSS} = 60V$   
 $R_{DS(on)} = 0.20\Omega$   
 $I_D = 10A$



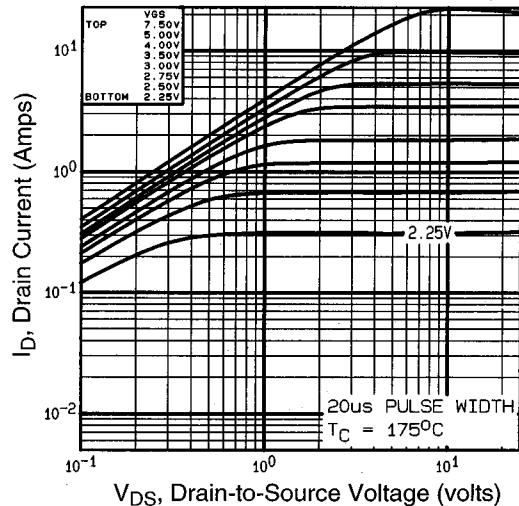
### Absolute Maximum Ratings

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$ <sup>⑤</sup>	10	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$ <sup>⑤</sup>	7.2	
$I_{DM}$	Pulsed Drain Current ①⑤	40	
$P_D @ T_A = 25^\circ C$	Power Dissipation	3.7	W
$P_D @ T_C = 25^\circ C$	Power Dissipation	43	W
	Linear Derating Factor	0.29	W/°C
$V_{GS}$	Gate-to-Source Voltage	± 10	V
$E_{AS}$	Single Pulse Avalanche Energy②⑤	68	mJ
$dv/dt$	Peak Diode Recovery dv/dt ③⑤	4.5	V/ns
$T_J$	Operating Junction and	-55 to + 175	°C
$T_{STG}$	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case )	

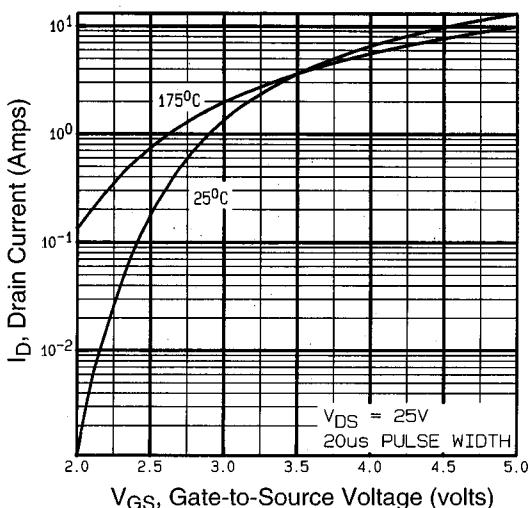




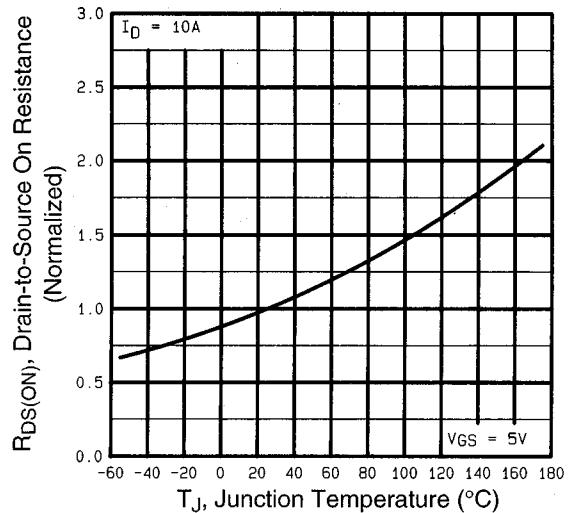
**Fig 1.** Typical Output Characteristics,



**Fig 2.** Typical Output Characteristics,



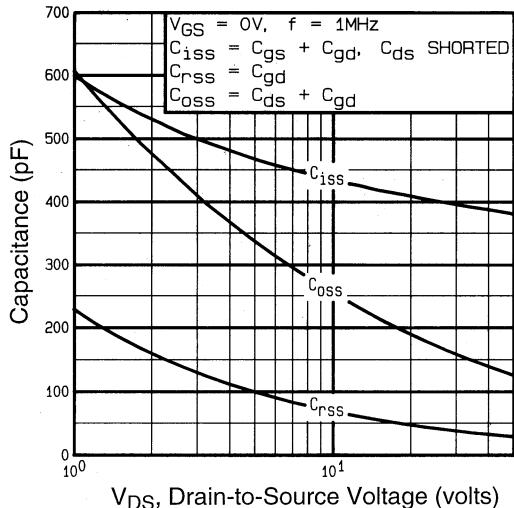
**Fig 3.** Typical Transfer Characteristics



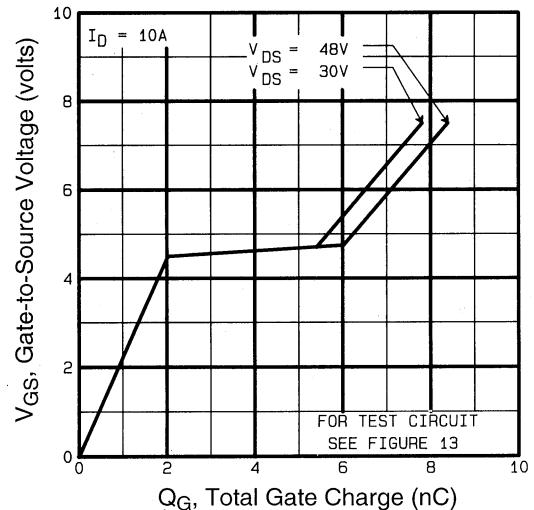
**Fig 4.** Normalized On-Resistance  
Vs. Temperature

# IRLZ14S/L

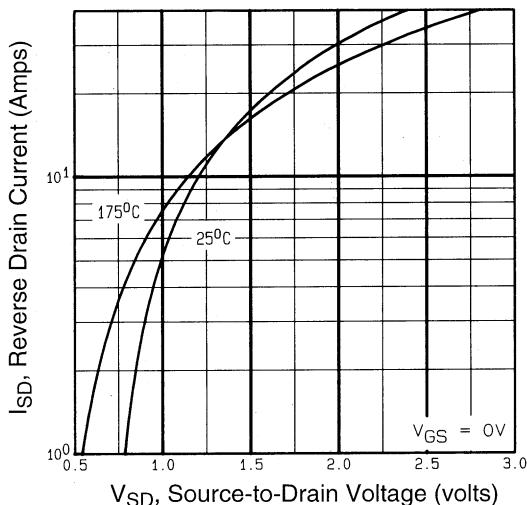
International  
**IR** Rectifier



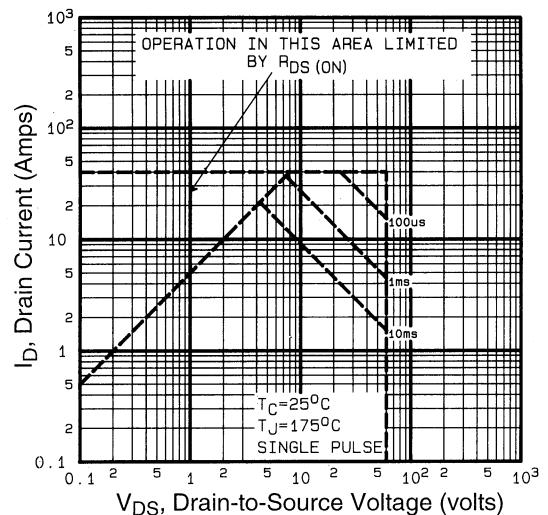
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



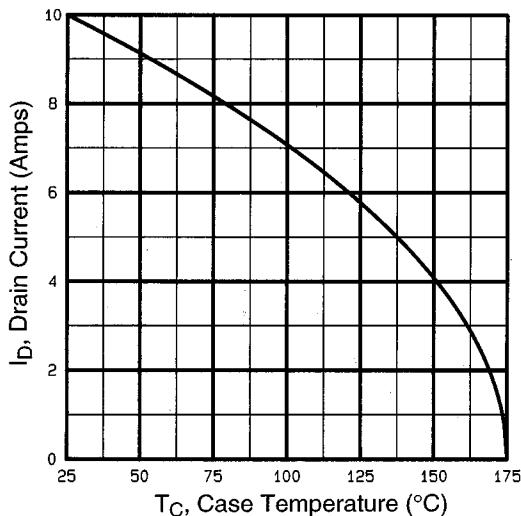
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



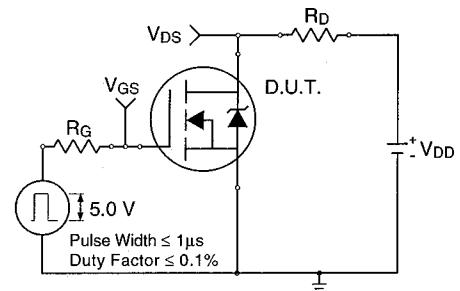
**Fig 7.** Typical Source-Drain Diode  
Forward Voltage



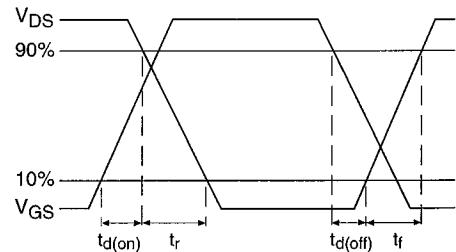
**Fig 8.** Maximum Safe Operating Area



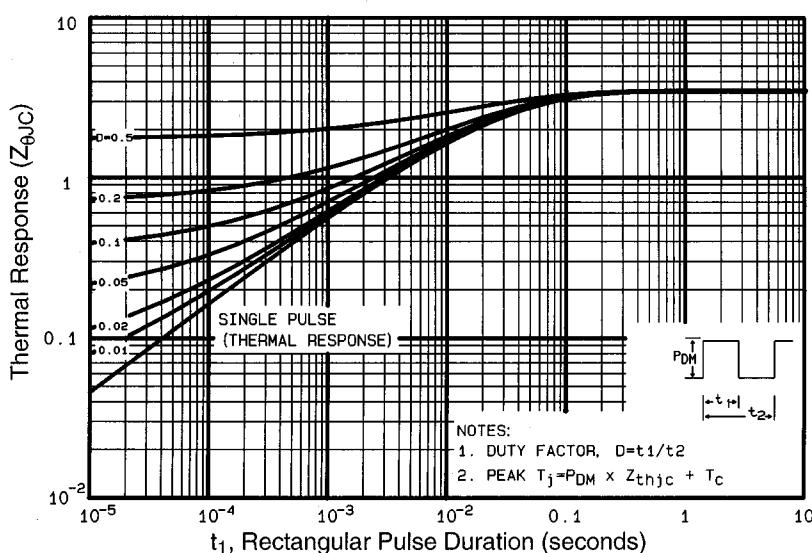
**Fig 9.** Maximum Drain Current Vs.  
Case Temperature



**Fig 10a.** Switching Time Test Circuit



**Fig 10b.** Switching Time Waveforms



**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

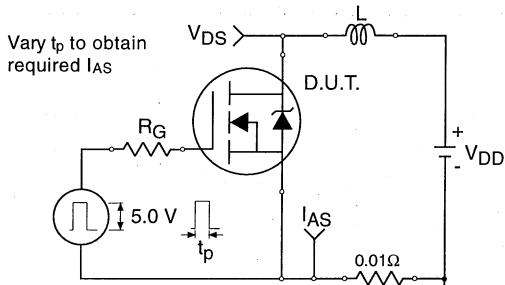


Fig 12a. Unclamped Inductive Test Circuit

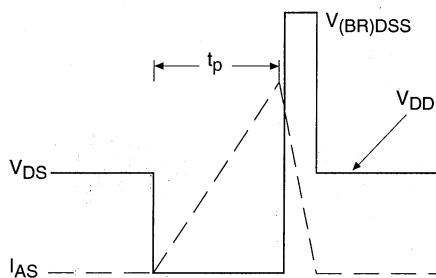


Fig 12b. Unclamped Inductive Waveforms

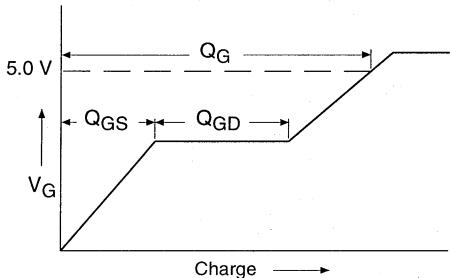


Fig 13a. Basic Gate Charge Waveform

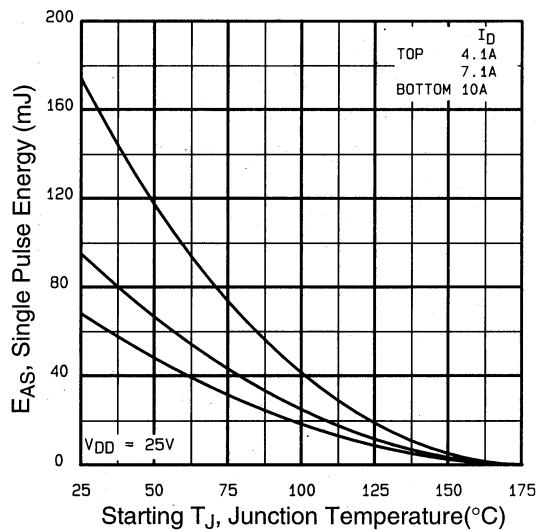


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

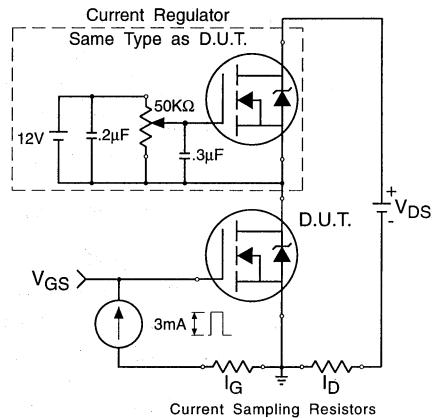
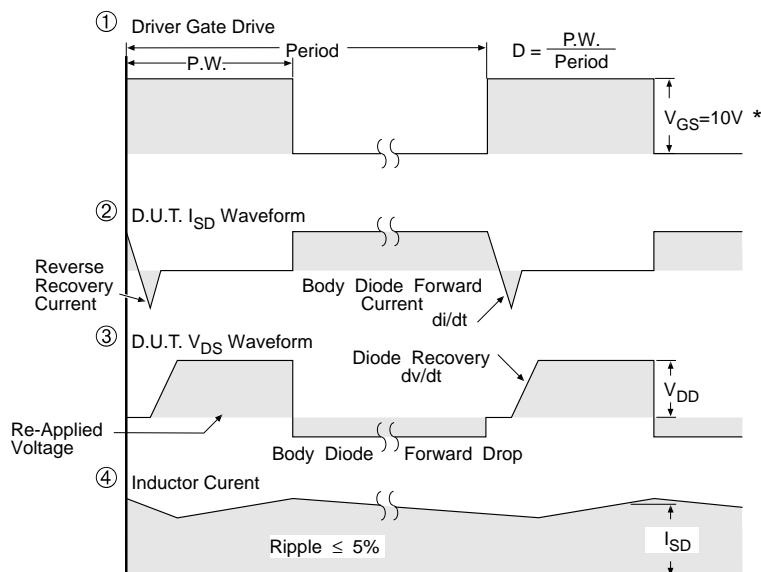
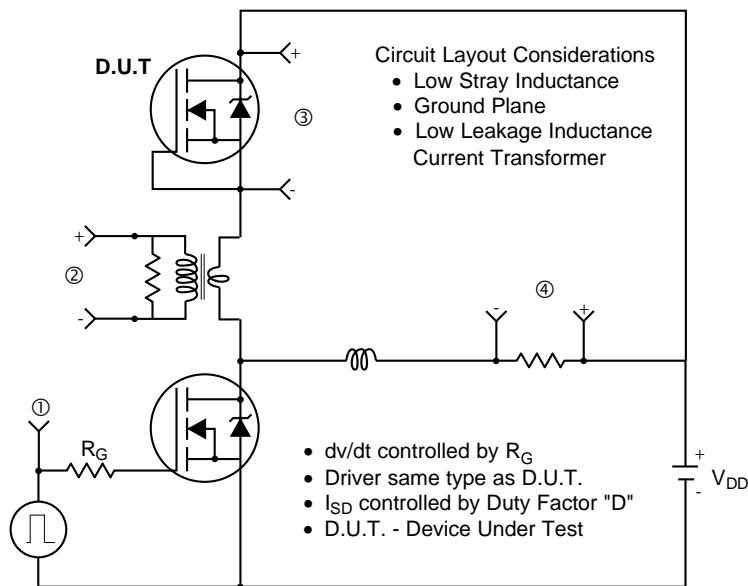


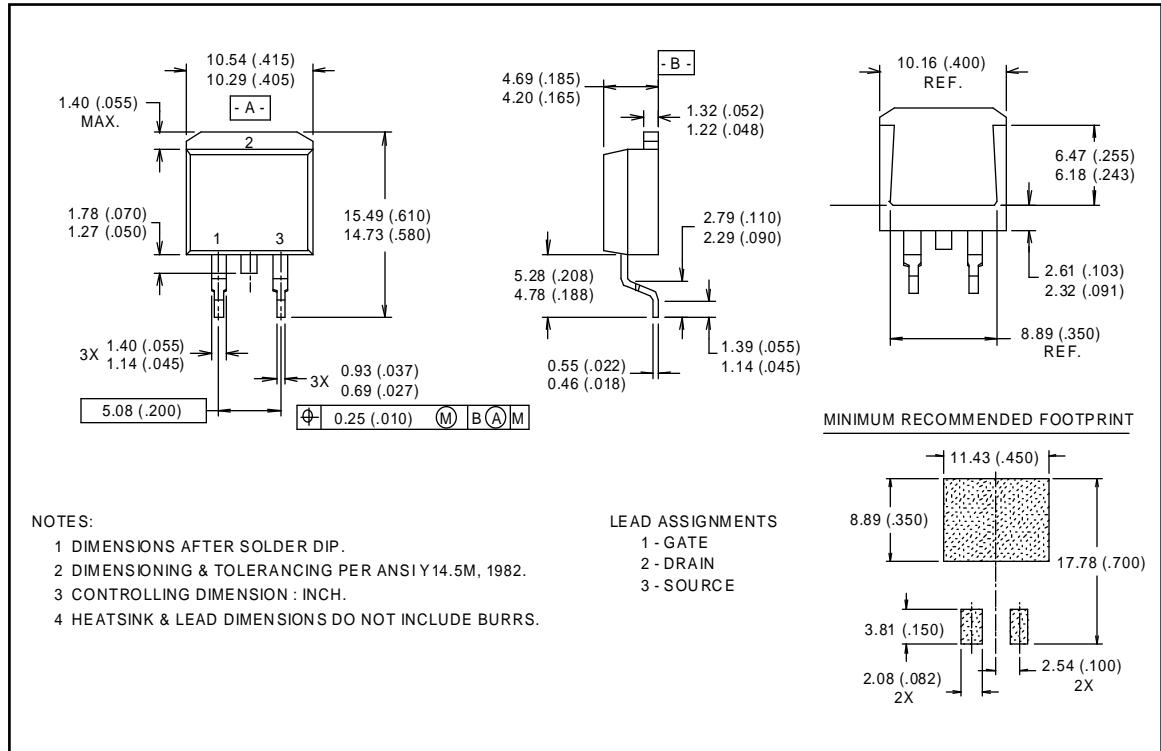
Fig 13b. Gate Charge Test Circuit

### Peak Diode Recovery dv/dt Test Circuit

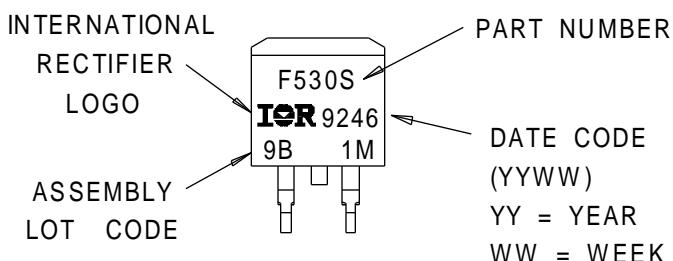


\*  $V_{GS} = 5V$  for Logic Level Devices

**Fig 14.** For N-Channel HEXFETs

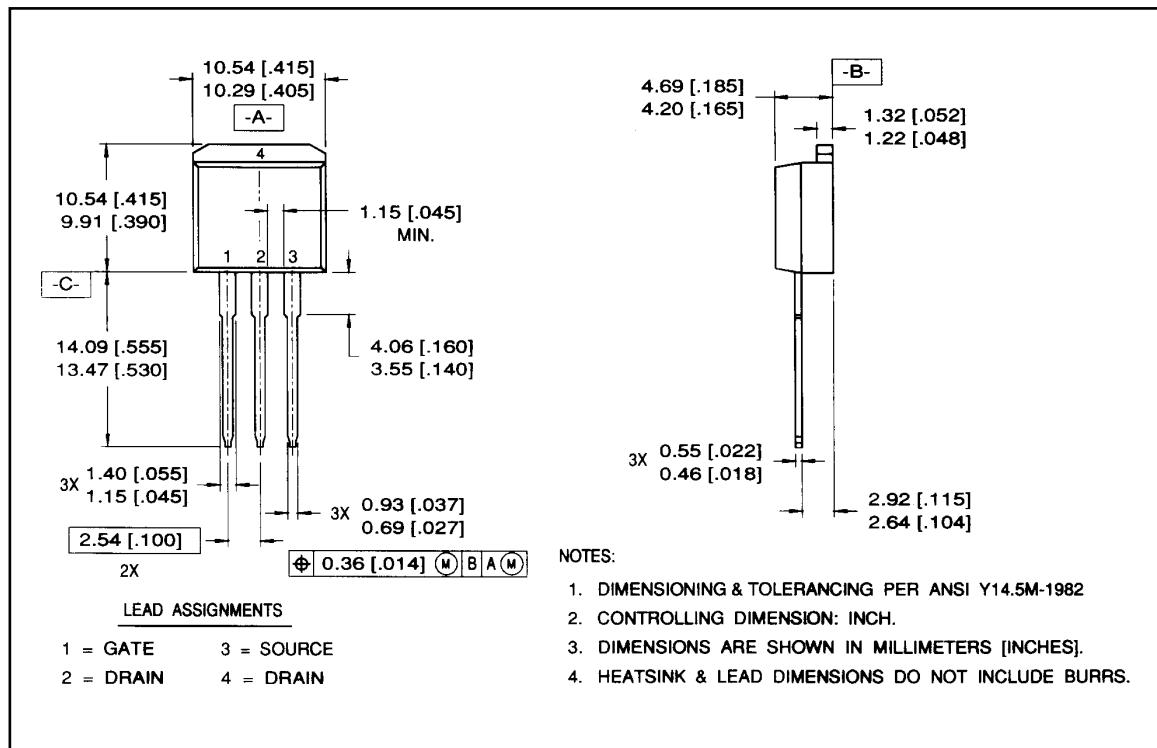
D<sup>2</sup>Pak Package Outline

## Part Marking Information

D<sup>2</sup>Pak

## Package Outline

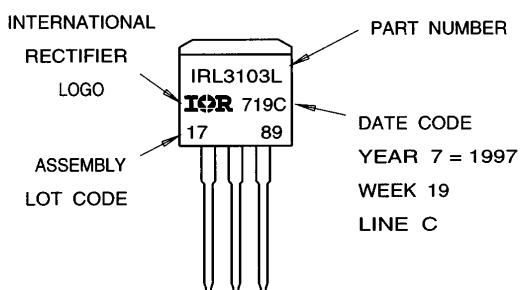
### TO-262 Outline



## Part Marking Information

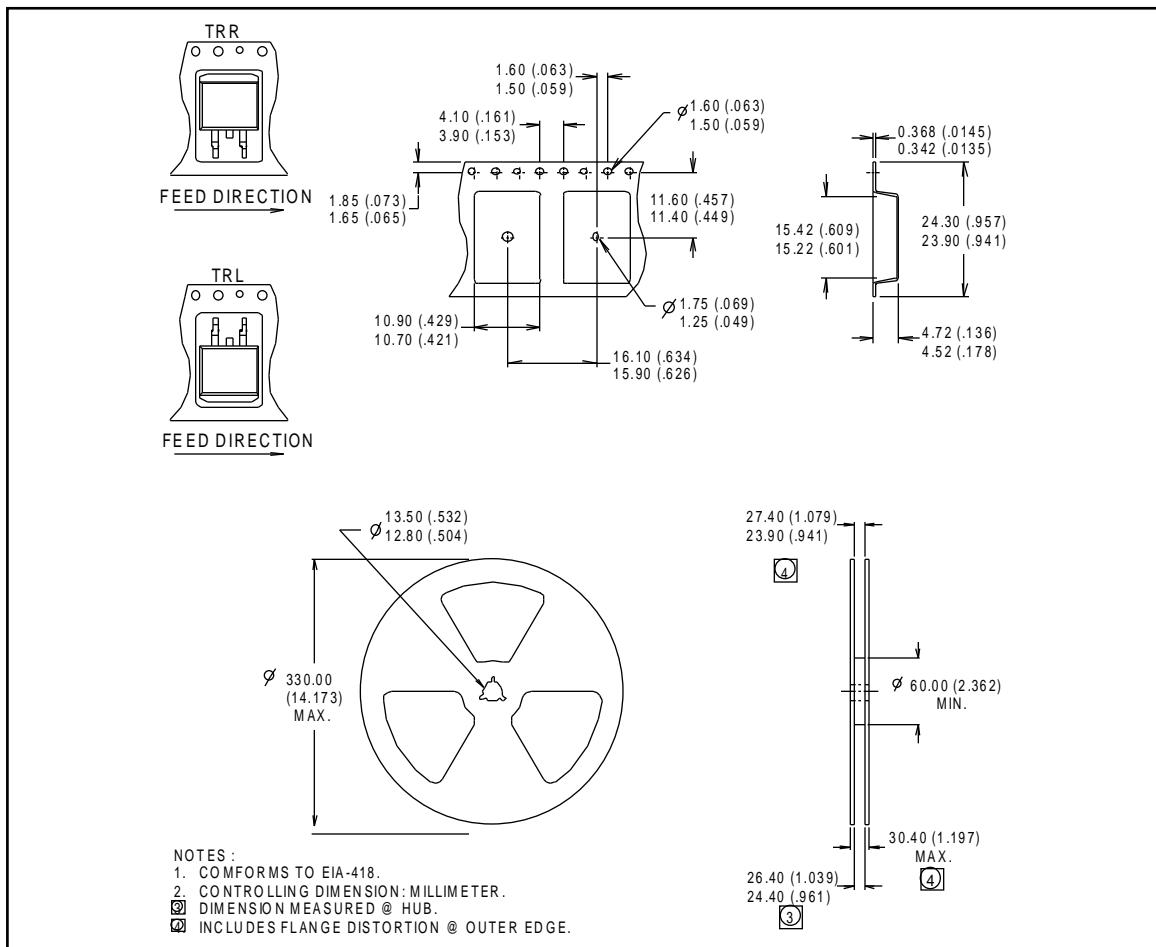
### TO-262

EXAMPLE: THIS IS AN IRL3103L  
LOT CODE 1789  
ASSEMBLED ON WW 19, 1997  
IN THE ASSEMBLY LINE "C"



## Tape & Reel Information

D<sup>2</sup>Pak



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**IR CANADA:** 7321 Victoria Park Ave., Suite 201, Markham, Ontario L3R 2Z8, Tel: (905) 475 1897

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